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### **LED Middle POWER**

**5630 Product Data Sheet** 

### SZPXX Series

Created Date: 03 / 12 / 2014 Revision: 2.0, 05 / 9 / 2014



Lite-on Technology Corp. www.liteon.com



### 1. Description

The LiteON 5630 Product series is a wide beam angle standard-dimension package, combining the lifetime and reliability advantages of Light Emitting Diodes with the brightness of conventional lighting. It gives you total design freedom and unmatched brightness, creating a new opportunities for solid state lighting to displace conventional lighting technologies.

#### 1.1 Features

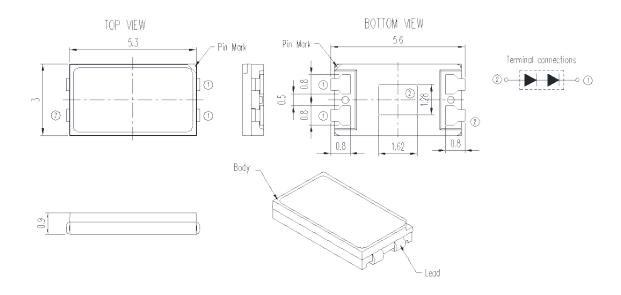
- Package in 8mm tape on 7" diameter reels.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- EIA STD package.
- I.C. compatible.
- Meet green product and Pb-free(According to RoHS)

#### 1.2 Available Part Numbers

ССТ	Part Number
6500K	LTW-5630SZP65
5700K	LTW-5630SZP57
5000K	LTW-5630SZP50
4000K	LTW-5630SZP40
3500K	LTW-5630SZP35
3000K	LTW-5630SZP30
2700K	LTW-5630SZP27



### 2. Outline Dimensions



Part No.	Lens Color	Source Color
LTW-5630SZP65		
LTW-5630SZP57		
LTW-5630SZP50		
LTW-5630SZP40	Orange	InGaN Blue
LTW-5630SZP35		
LTW-5630SZP30		
LTW-5630SZP27		

#### Notes:

- 1. All dimensions are in millimeters.
- 2. Tolerance is ±0.2 mm (.008") unless otherwise noted.



### 3. Absolute Maximum Ratings at T<sub>a</sub>=25°C

Parameter	Symbol	Rating	Unit
Power Dissipation	Po	750	mW
Continuous Forward Current	l <sub>F</sub>	120	mA
Pulse Forward Current	I <sub>FP</sub>	130	mA
Operating Temperature Range	$T_{opr}$	-40 ~ +85	°C
Storage Temperature Range	T <sub>stg</sub>	-40 ~ +100	°C
Junction Temperature	T <sub>j</sub>	≦120	°C

#### Notes:

- 1. 1/10 duty cycle, Pulse width  $\leq$ 100  $\mu$  s.
- 2. Forbid to operating at reverse voltage condition for long.
- 3. It is recommended to follow de-rating curve to use maximum rating to ensure LED can operated normally.



#### 4. Electro-Optical Characteristics

#### 4.1 Typical Performance

Parameter	Symbol				Va		Unit	Test Condition			
Correlated Color Temp.	ССТ	Тур.	2700	3000	3500	4000	5000	5700	6500	K	
Chromaticity Coordinates	Х	Тур.	0.458	0.434	0.408	0.382	0.345	0.329	0.312		
Chromaticity Coordinates	у	Тур.	0.410	0.403	0.392	0.380	0.355	0.342	0.328	_	
		Min	25.2	26.1	27.0	27.0	27.0	27.0	27.0		
Luminous Flux <sup>1</sup>	Фν	Тур.	28.9	30.4	31.0	31.6	32.0	31.9	31.0	lm	
		Мах.	33.0	33.8	34.7	34.7	34.7	34.7	34.7		
Optical Efficiency	$\eta_{\text{opt}}$	Тур.	162	171	174	178	180	179	174	lm/W	/ 00 Em A
Color Rendering Index	CRI	Min.				80				-	$I_{\rm F}=32.5{\rm mA}$
Viewing Angle	2θ <sub>1/2</sub>	Тур.				120				deg	
		Min				5.2					
Forward Voltage	$V_{F}$	Тур.				5.5				V	
		Мах.				6.0					
Thermal Resistance	$R_{jt}$	Тур. 15								°C/W	
ESD-Withstand Voltage	ESD	Min	Min 2K							HBM	V

#### **Notes**

- 1. Luminous flux is the total luminous flux output as measured with an integrating sphere.
- 2. Iv (flux  $\Phi_v$ ) classification code is marked on each packing bag.
- 3. The chromaticity coordinates (x, y) is derived from the 1931 CIE chromaticity diagram.
- 4. Caution in ESD:

Static Electricity and surge damages the LED. It is recommended using a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

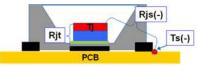
- 5. CAS140B is the test standard for the chromaticity coordinates (x, y) &  $\Phi_{v}$ .
- 6. The chromaticity coordinates (x, y) guarantee should be added +/- 0.01 tolerances
- 7. CRI measurement allowance is ±5, R9 of all CCT is >0.
- 8. The thermal resistance is defined

as the figure, Rit is the Rth from Ti to thermal pad solder:

Reference for thermal resistance:

Using 2.5x 2.5x 0.17 cm aluminum MCPCB,

 $R_{jt}=15$  °C/W,  $R_{js}=19$  °C/W



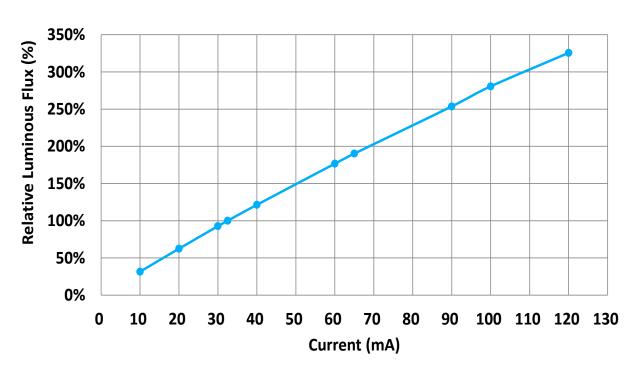
- ◆ Rjs = Rth of Tj to Ts
- ◆ Rjt = Rth of Tj to Thermal pad solder ◆ Rth definition in Datasheet = Rjt

- ◆ Rjt < Rjc</li>◆ Tj = Rjs\*W+Ts



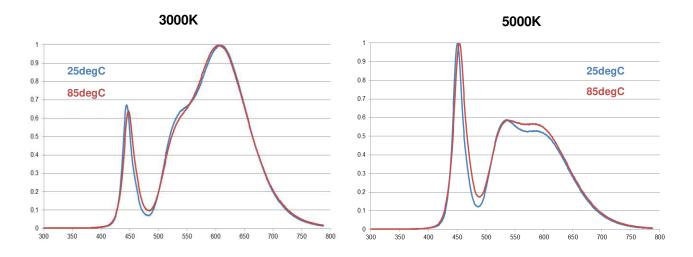
#### 4.2 Forward Current vs. Lumen and Voltage

Current	VF				Lumen (Im)			
(mA)	(V)	2700K	3000K	3500K	4000K	5000K	5700K	6500K
10.0	5.24	9.1	9.6	9.8	10.0	10.1	10.1	9.8
20.0	5.35	18.0	19.0	19.4	19.8	20.0	19.9	19.4
30.0	5.44	26.8	28.2	28.8	29.3	29.7	29.6	28.8
32.5	5.47	28.9	30.4	31.0	31.6	32.0	31.9	31.0
40.0	5.54	35.1	36.9	37.7	38.4	38.9	38.7	37.7
60.0	5.70	51.0	53.7	54.8	55.9	56.6	56.4	54.8
65.0	5.74	55.0	57.8	59.0	60.2	60.9	60.7	59.0
90.0	5.92	73.3	77.1	78.7	80.3	81.2	80.9	78.7
100.0	5.97	81.1	85.3	87.1	88.8	89.9	89.5	87.1
120.0	6.06	94.0	99.0	101.0	103.0	104.3	103.9	101.0

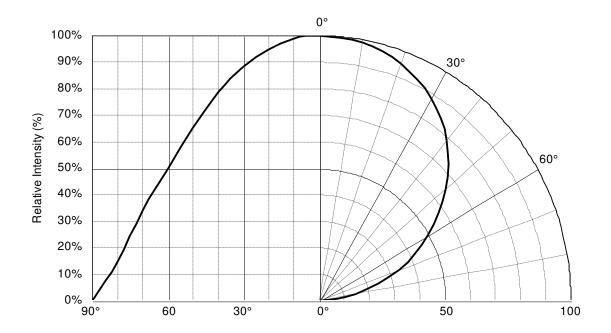




#### 4.3 Relative Spectral Power Distribution at Typical Current

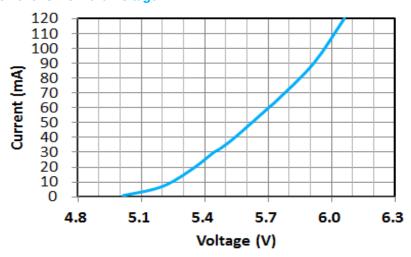


#### 4.4 Radiation Characteristics



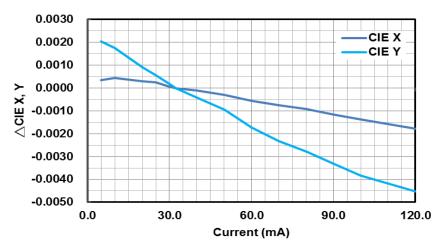


#### 4.5 Forward Current vs. Forward Voltage

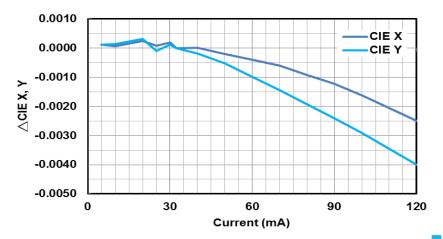


#### 4.2 Color Shift vs. Forward Current

#### Cool White

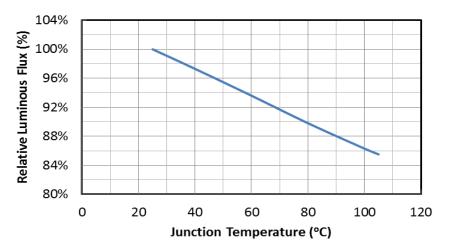


#### **■** Warm White

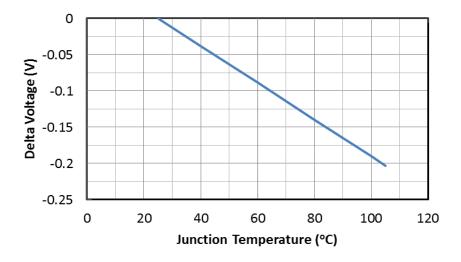




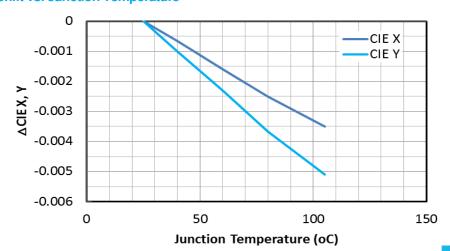
#### 4.2 Relative Intensity vs. Junction Temperature



#### 4.3 Voltage vs. Junction Temperature



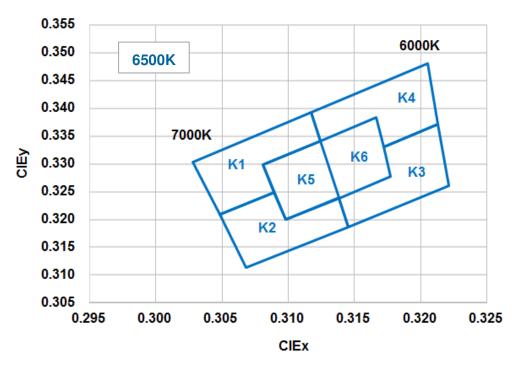
#### 4.4 Color Shift vs. Junction Temperature

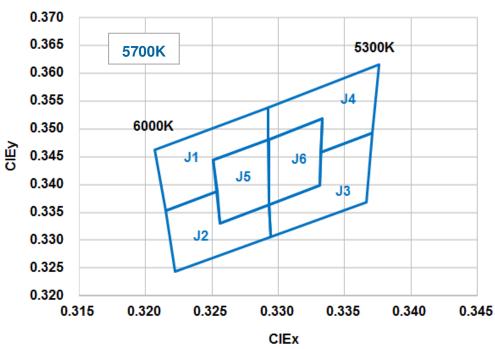




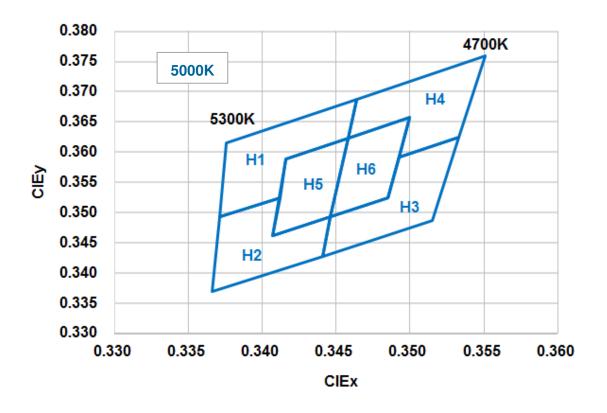
### 5. Binning Definition

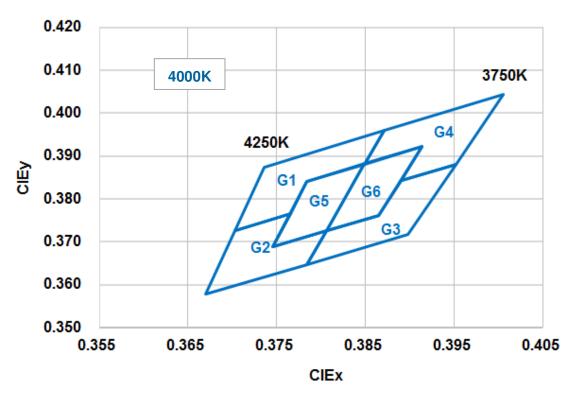
#### 5.1 Color Bin



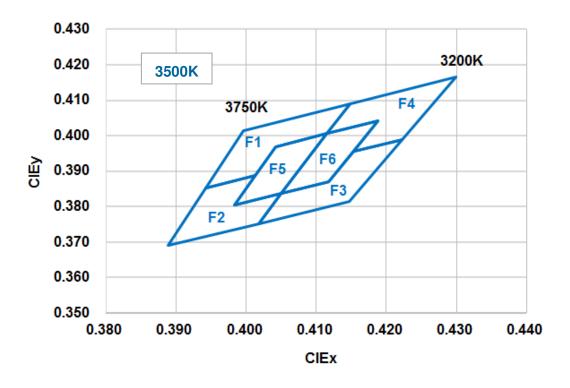


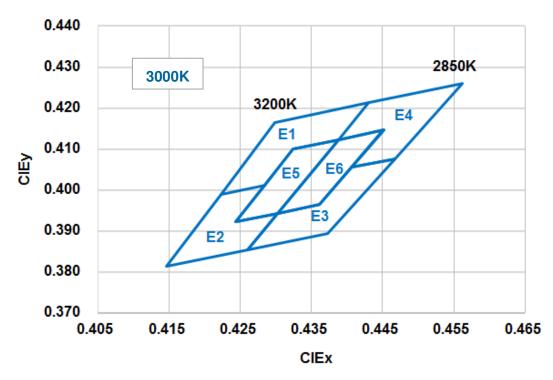




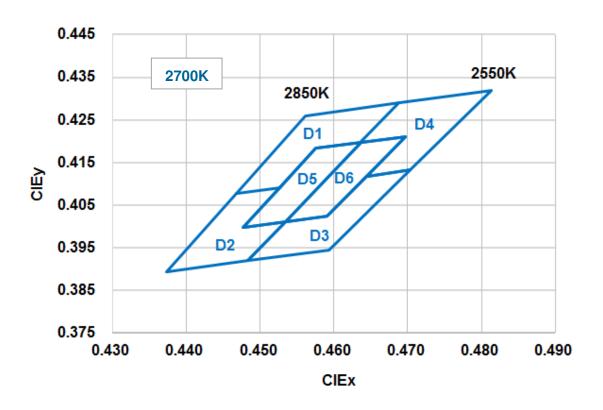














#### 5.2 Color Rank

				65	00K	$(I_{\rm F} = 32.5)$	mA)				
Rank	-	х	у	Rank	-	х	у	Rank	-	х	у
	1	0.3048	0.3209		1	0.3145	0.3187		1	0.3098	0.320
	2	0.3028	0.3304		2	0.3138	0.3238		2	0.3081	0.3299
V4	3	0.3117	0.3393	КЗ	3	0.3177	0.3277	VE	3	0.3124	0.3342
K1	4	0.3124	0.3341		4	0.3172	0.3330	K5	4	0.3138	0.3239
	5	0.3081	0.3299		5	0.3213	0.3371				
	6	0.3089	0.3249		6	0.3221	0.3261				
	1	0.3068	0.3113		1	0.3117	0.3393		1	0.3138	0.3239
	2	0.3048	0.3209		2	0.3205	0.3481		2	0.3124	0.3342
K0	3	0.3089	0.3249	K4	3	0.3213	0.3371	νc	3	0.3167	0.3384
K2	4	0.3098	0.32	N4	4	0.3172	0.333	K6	4	0.3178	0.3277
	5	0.3138	0.3238		5	0.3166	0.3384				
	6	0.3145	0.3187		6	0.3124	0.3341				

Tolerance on each Hue bin (x,y) is  $\pm$  0.01.

				57	00K	$(I_{\rm F} = 32.5)$	mA)				
Rank	-	х	у	Rank	-	x	у	Rank	-	х	у
	1	0.3215	0.3353		1	0.3294	0.3306		1	0.3256	0.3331
	2	0.3207	0.3462		2	0.3293	0.3364		2	0.3251	0.3444
14	3	0.3292	0.3539	J3 -	3	0.3331	0.3398	J5	3	0.3292	0.3481
J1	4	0.3292	0.3481		4	0.3332	0.3458	Jo	4	0.3293	0.3364
	5	0.3251	0.3444		5	0.3371	0.3493				
	6	0.3254	0.3388		6	0.3366	0.3369				
	1	0.3222	0.3243		1	0.3292	0.3539		1	0.3293	0.3364
	2	0.3215	0.3353		2	0.3376	0.3616		2	0.3293	0.3481
10	3	0.3254	0.3388	J4	3	0.3371	0.3493	16	3	0.3333	0.3518
J2	4	0.3256	0.3331	J4	4	0.3332	0.3458	J6	4	0.3331	0.3398
	5	0.3293	0.3364		5	0.3333	0.3518				
	6	0.3294	0.3306		6	0.3292	0.3481				

Tolerance on each Hue bin (x,y) is  $\pm -0.01$ .



				50	00K	$(I_{\rm F} = 32.5)$	mA)				
Rank	-	х	у	Rank	-	x	у	Rank	-	х	у
	1	0.3371	0.3493		1	0.3441	0.3428		1	0.3407	0.3462
	2	0.3376	0.3616	НЗ	2	0.3446	0.3493		2	0.3416	0.3589
114	3	0.3464	0.3688		3	0.3485	0.3524	115	3	0.3458	0.3623
H1	4	0.3458	0.3623		4	0.3493	0.3591	H5	4	0.3446	0.3493
	5	0.3416	0.3589		5	0.3533	0.3624				
	6	0.3412	0.3525		6	0.3515	0.3487				
	1	0.3366	0.3369		1	0.3464	0.3688		1	0.3446	0.3493
	2	0.3371	0.3493		2	0.3551	0.3760		2	0.3458	0.3623
110	3	0.3412	0.3525	114	3	0.3533	0.3624	110	3	0.3500	0.3657
H2	4	0.3407	0.3462	H4	4	0.3493	0.3591	H6	4	0.3485	0.3524
	5	0.3446	0.3493		5	0.3500	0.3657				
	6	0.3441	0.3428		6	0.3458	0.3623				

Tolerance on each Hue bin (x,y) is  $\pm$ -0.01.

				40	00K	$(I_{\rm F}=32.5$	mA)				
Rank	-	х	у	Rank	-	x	у	Rank	-	х	у
	1	0.3703	0.3726		1	0.3784	0.3647		1	0.3746	0.3689
	2	0.3736	0.3874	G3	2	0.3806	0.3725		2	0.3784	0.3841
C1	3	0.3871	0.3959		3	0.3865	0.3762	G5	3	0.3849	0.3882
G1	4	0.3849	0.3881		4	0.3890	0.3842		4	0.3806	0.3726
	5	0.3784	0.3841		5	0.3952	0.3880				
	6	0.3766	0.3765		6	0.3898	0.3716				
	1	0.3670	0.3578		1	0.3871	0.3959		1	0.3806	0.3726
	2	0.3703	0.3726		2	0.4006	0.4044		2	0.3849	0.3882
G2	3	0.3766	0.3765	64	3	0.3952	0.3880	CG	3	0.3914	0.3922
G2	4	0.3746	0.3689	G4	4	0.3890	0.3842	G6	4	0.3865	0.3762
	5	0.3806	0.3725		5	0.3914	0.3922				
	6	0.3784	0.3647		6	0.3849	0.3881				_

Tolerance on each Hue bin (x,y) is  $\pm -0.01$ .



				35	00K	$(I_{\rm F} = 32.5)$	mA)				
Rank	-	х	у	Rank	-	х	у	Rank	-	х	у
	1	0.3943	0.3853		1	0.4018	0.3752		1	0.3983	0.3804
	2	0.3996	0.4015		2	0.4050	0.3837		2	0.4042	0.3970
F4	3	0.4148	0.4090	<b>F</b> 0	3	0.4118	0.3869	FF	3	0.4115	0.4006
F1	4	0.4115	0.4006	F3	4	0.4153	0.3955	F5	4	0.4050	0.3837
	5	0.4042	0.3970		5	0.4223	0.3990				
	6	0.4013	0.3887		6	0.4147	0.3814				
	1	0.3889	0.3690		1	0.4148	0.4090		1	0.4050	0.3837
	2	0.3943	0.3853		2	0.4299	0.4165		2	0.4115	0.4006
F0	3	0.4013	0.3887	<b>5</b> 4	3	0.4223	0.3990	FC	3	0.4188	0.4041
F2	4 0.3983 0.3804 <b>F4</b>	F4	4	0.4153	0.3955	F6	4	0.4118	0.3869		
	5	0.4050	0.3837		5	0.4188	0.4041				
	6	0.4018	0.3752		6	0.4115	0.4006				

Tolerance on each Hue bin (x,y) is  $\pm -0.01$ .

3000K ( <i>I<sub>F</sub></i> = 32.5 mA)												
Rank	-	x	у	Rank	-	х	у	Rank	-	х	у	
	1	0.4223	0.3990		1	0.4260	0.3854		1	0.4244	0.3923	
	2	0.4299	0.4165		2	0.4303	0.3943		2	0.4324	0.4100	
E1	3	0.4431	0.4213	E3	3	0.4361	0.3964	E5	3	0.4388	0.4123	
E1	4	0.4388	0.4123		4	0.4406	0.4055	E9	4	0.4303	0.3944	
	5	0.4324	0.4100		5	0.4468	0.4077					
	6	0.4284	0.4011		6	0.4373	0.3893					
	1	0.4147	0.3814		1	0.4431	0.4213		1	0.4303	0.3944	
	2	0.4223	0.3990		2	0.4562	0.4260		2	0.4388	0.4123	
ΕO	3	0.4284	0.4011	E4	3	0.4468	0.4077	Ee	3	0.4452	0.4146	
E2	4	0.4244	0.3923	E4	4	0.4406	0.4055	<b>E</b> 6	4	0.4361	0.3964	
	5	0.4303	0.3943		5	0.4451	0.4146					
	6	0.4260	0.3854		6	0.4388	0.4123					

Tolerance on each Hue bin (x,y) is  $\pm -0.01$ .



				27	00K	$(I_{\rm F} = 32.5)$	mA)				
Rank	-	х	у	Rank	-	x	у	Rank	-	х	У
	1	0.4468	0.4077		1	0.4483	0.3919		1	0.4477	0.3998
	2	0.4562	0.4260		2	0.4534	0.4011		2	0.4576	0.4183
D1	3	0.4688	0.4290	D3	3	0.4591	0.4025	D5	3	0.4637	0.4197
וט	4	0.4636	0.4197		4	0.4644	0.4118	<b>D</b> 3	4	0.4534	0.4012
	5	0.4576	0.4183		5	0.4703	0.4132				
	6	0.4527	0.4090		6	0.4593	0.3944				
	1	0.4373	0.3893		1	0.4688	0.4290		1	0.4534	0.4012
	2	0.4468	0.4077		2	0.4813	0.4319		2	0.4637	0.4197
D2	3	0.4527	0.4090	D4	3	0.4703	0.4132	De	3	0.4697	0.4211
D2	4 0.4477 0.3998 <b>D</b>	D <del>4</del>	4	0.4644	0.4118	D6	4	0.4591	0.4025		
	5	0.4534	0.4011		5	0.4697	0.4211				
	6	0.4483	0.3919		6	0.4636	0.4197				

Tolerance on each Hue bin (x,y) is  $\pm$ -0.01.



#### 5.3 Flux Bin

2700K	$\Phi_{\rm v}$ Luminous Flux Spec. Table		
Ф Pin	Lumen (lm) at $I_F = 32.5 \text{ mA}$		
$\Phi_{ m v}$ Bin	Min	Max	
FH	25.2	26.8	
HL	26.8	30.5	
LO	30.5 33.0		

3000K	$\Phi_{ m v}$ Luminous Flux Spec. Table			
Ф Din	Lumen (lm) at $I_F = 32.5 \text{ mA}$			
$\Phi_{ m v}$ Bin	Min			
GJ	26.1	28.8		
JM	28.8	31.3		
MP	31.3 33.8			

3500K	$\Phi_{ m v}$ Luminous Flux Spec. Table			
Φ. Dia	Lumen (lm) at $I_F = 32.5 \text{ mA}$			
$\Phi_{\rm v}$ Bin	Min Max			
HK	27.0	29.7		
KN	29.7	32.2		
NQ	32.2 34.7			

4000K	$\Phi_{ m v}$ Luminous Flux Spec. Table		
ф Din	Lumen (lm) at $I_F = 32.5 \text{ mA}$ Min  Max		
$\Phi_{\rm v}$ Bin			
HK	27.0	29.7	
KN	29.7	32.2	
NQ	32.2 34.7		

5000K	$\Phi_{ m v}$ Luminous Flux Spec. Table		
љ. D:	Lumen (lm) at $I_F = 32.5 \text{ mA}$		
$\Phi_{\rm v}$ Bin	Min	Max	
HK	27.0	29.7	
KN	29.7	32.2	
NQ	32.2 34.7		

5700K	$\Phi_{ m v}$ Luminous Flux Spec. Table		
Ф Din	Lumen (lm) at $I_F = 32.5 \text{ mA}$		
$\Phi_{ m v}$ Bin	Min	Max	
HK	27.0	29.7	
KN	29.7	32.2	
NQ	32.2 34.7		

6500K	$\Phi_{ m v}$ Luminous Flux Spec. Table		
σ. Din	Lumen (lm) at $I_F = 32.5 \text{ mA}$		
$\Phi_{ m v}$ Bin	Min	Max	
HK	27.0	29.7	
KN	29.7	32.2	
NQ	32.2 34.7		

Tolerance on each Luminous Flux bin is +/- 10%.



#### 5.4 Voltage Bin

V <sub>F</sub> Spec. Table				
Forward Voltage (volts) at I <sub>F</sub> = 32.5 mA				
V <sub>F</sub> DIII	Min Max			
V1	5.2	5.4		
V2	5.4	5.6		
V3	5.6	5.8		
V4	5.8	6.0		

Tolerance on each Forward Voltage bin is +/- 0.1V

#### 6. Bin Code List

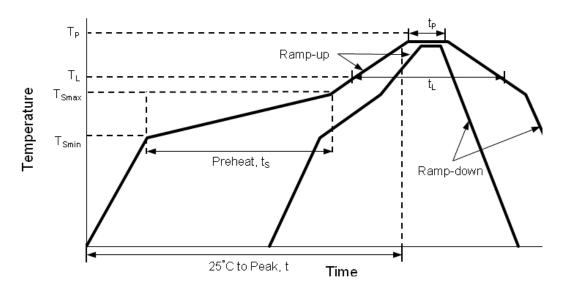
**% Notes: Full Rank on Label** 

Example: V1 / KN / G5

Forward Voltage Rank	Luminous Flux Rank	Color Rank
V1	KN	G5



### 7. Reflow Soldering Characteristics



Profile Feature	Lead Free Assembly
Average Ramp-Up Rate (T <sub>Smax</sub> to T <sub>P</sub> )	3°C / second max
Preheat Temperature Min (T <sub>Smin</sub> )	150°C
Preheat Temperature Max (T <sub>Smax</sub> )	200°C
Preheat Time (t <sub>Smin</sub> to t <sub>Smax</sub> )	60 – 180 seconds
Time Maintained Above Temperature (T <sub>L</sub> )	217°C
Time Maintained Above Time (t <sub>L</sub> )	60 - 150 seconds
Peak / Classification Temperature (T <sub>P</sub> )	260°C
Time Within 5°C of Actual Peak Temperature (t <sub>P</sub> )	5 seconds
Ramp – Down Rate	6°C / second max
Time 25°C to Peak Temperature	8 minutes max

#### **Notes:**

- The LEDs can be soldered using the reflow soldering or hand soldering method. The recommended hand soldering condition is 350 °C max. and 2 secs max. for one time only, and the recommended reflow soldering condition is 260 °C max. and 5 secs max. for three times max.
- 2. All temperatures refer to topside of the package, measured on the package body surface.



- 3. The soldering condition referring to J-STD-020B. The storage ambient for the LEDs should not exceed 30 °C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are soldered within one week. For extended storage out of their original packaging, it is recommended that the LEDs were stored in a sealed container with appropriate desiccant, or desiccators with nitrogen ambient. If the LEDs were unpacked more than 168hrs, baking the LEDs at 60 °C for 24hrs before soldering process.
- 4. The soldering profile could be further referred to different soldering grease material characteristic. The grease vendor will provide this information.
- 5. A rapid-rate process is not recommended for the LEDs cooling down from the peak temperature.
- 6. Although the recommended reflow conditions are specified above, the reflow or hand soldering condition at the lowest possible temperature is desirable for the LEDs.
- LiteOn cannot make a guarantee on the LEDs which have been already assembled using the dip soldering method.



### 8. Reliability Test

No	Test item	Test Condition	Duration	Number of Damaged
1	Steady State Operating Life of High Temperature (HTOL)	Ts=55°ℂ, <i>I</i> <sub>F</sub> =60 mA	1000 hrs	0/20
2	Steady State Operating Life of High Temperature (HTOL)	Ts=85°ℂ , <i>I</i> <sub>F</sub> =60 mA	1000 hrs	0/20
3	Steady State Operating Life of Low Temperature (LTOL)	Ta=-40°ℂ , <i>I</i> <sub>F</sub> =60 mA	1000 hrs	0/20
4	Pulse Wet Operating Life of High Temperature (PWHTOL)	60°C/90%RH, <i>I</i> <sub>F</sub> =60 mA 30mins ON/30min OFF	500 hrs	0/20
5	High Temperature Storage (HTS)	<b>100</b> ℃	1000 hrs	0/20
6	Low Temperature Storage (LTS)	-40°C	1000 hrs	0/20
7	Thermal Cycle (TC)	-40°C ~100°C 30min dwell 5min transfer	200 cycles	0/20
8	Thermal Shock (TS)	-40°C~100°C 20min dwell 20sec transfer	200 cycles	0/20
9	Solder Resistance (SR)	265℃, 3X MSL	5sec	0/20
10	Solder Ability (SA)	245°C 5sec, 95% coverage	5sec	0/11
11	Mechanical Shock (MS) 1500G 0.5msec pulse shock		each 6 axis	0/6
12	Random Vibration (RV)	6G RMS, 10-2000Hz, 10min	per axis	0/6
13	Variable Vibration Frequency (VVF)	10-2000-10Hz, log or linear sweep rate, 20G for 1 min, 1.5mm each apply 3x per axis	over 6hrs	0/6
14	Salt Spread (SS)	35°C, 30g/m²/day	48hrs	0/11

#### ■ Criteria for Judging the Damage

lione	Cumbal	Toot Condition	Criteria for	Judgment
Item	Symbol	Test Condition Min.		Max.
Forward Voltage	$V_{F}$	<i>I</i> <sub>F</sub> =Typical Current		U.S.L. x 1.1
Luminous Flux	lm	<i>I</i> <sub>F</sub> =Typical Current	L.S.L. x 0.7	
CCX&CCY	x,y	<i>I</i> <sub>F</sub> =Typical Current		Shift<0.02



#### 9. User Guide

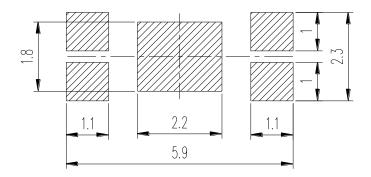
#### Cleaning

Do not use unspecified chemical liquid to clean LED they could harm the package. If cleaning is necessary, immerse the LED in ethyl alcohol or isopropyl alcohol at normal temperature for less than one minute.

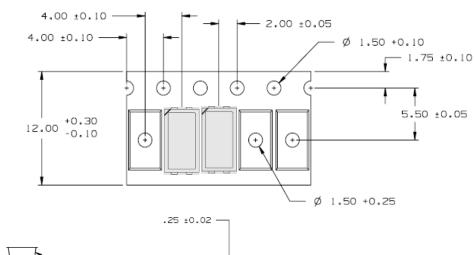
#### Recommend Printed Circuit Board Attachment Pad

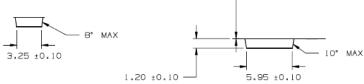
#### Infrared / vapor phase

#### **Reflow Soldering**



#### ■ Package Dimensions of Tape

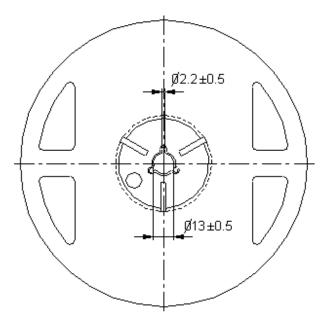




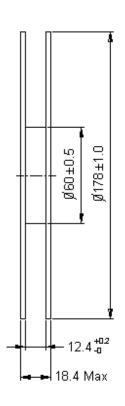
Note: All dimensions are in millimeters (inches).

#### Package Dimensions of Reel





Note: 01. The tolerance unless mentioned is±0.1mm 02. The measured unit is "mm"



#### **Notes:**

- 1. Empty component pockets sealed with top cover tape.
- 2. 7 inch reel-3000 pieces per reel.
- 3. Minimum packing quantity is 500 pieces for remainders.
- 4. The maximum number of consecutive missing lamps is two.
- 5. In accordance with EIA-481-1-B specifications.



#### 10. Cautions

#### 10.1 Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

#### 10.2 Storage

This product is qualified as Moisture sensitive Level 3 per JEDEC J-STD-020 Precaution when handing this moisture sensitive product is important to ensure the reliability of the product.

The package is sealed:

The LEDs should be stored at 30°C or less and 90%RH or less. And the LEDs are limited to use within one year, while the LEDs is packed in moisture-proof package with the desiccants inside.

The package is opened:

The LEDs should be stored at 30°C or less and 60%RH or less. Moreover, the LEDs are limited to solder process within 168hrs. If the Humidity Indicator shows the pink color in 10% even higher or exceed the storage limiting time since opened, that we recommended to baking LEDs at 60°C at least 24hrs. To seal the remainder LEDs return to package, it's recommended to be with workable desiccants in original package.

#### 10.3 Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.

#### 10.4 Drive Mode

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below

